

December 2007

BAS40SLSchottky Barrier Diodes

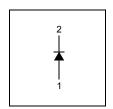
Features

- · Low Forward Voltage Drop
- · Fast switching
- · Very Small and Thin SMD package
- Profile height, 0.43mm max
- Footprint, 1.0 x 0.6 mm

Connection Diagram



SOD-923 Marking: AA



Absolute Maximum Ratings * T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{RRM}	Maximum Repetitive Reverse Voltage	40	V
I _{F(AV)}	Average Rectified Forward Current	100	mA
I _{FSM}	Forward Surge Current (8.3mS Single Half Sine-Wave)	600	mA
P _D	Power Dissipation	227	mW
T _{J,} T _{STG}	Operating Junction & Storage Temperature Range	re Range -55 to +150 °C	

^{*} These ratings are limiting values above which the serviceability of the diode may be impaired. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient *	550	°C/W

^{*} Minimum land pad.

Electrical Characteristics TA=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _R	Breakdown Voltage	I _R = 10μA	40		V
V _F	Forward Voltage	I _F = 1mA I _F = 40mA		380 1000	mV mV
I _R	Reverse Leakage	V _R = 30V		0.2	μА
trr	Reverse Recovery Time	$I_F = I_R = 10 \text{mA}, \text{ irr} = 0.1 I_R$		8.0	nS
C _j	Junction Capacitance	V _R = 0, f = 1.0MHz		5.0	pF

Typical Performance Characteristics

Figure 1. Forward Current Characteristics

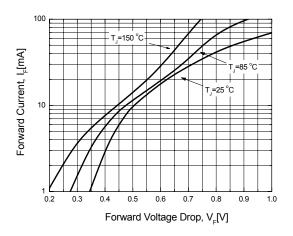


Figure 2. Reverse Leakage Current

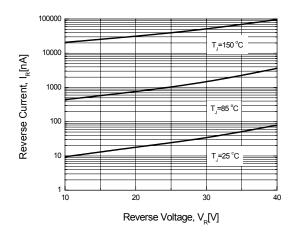


Figure 3. Junction Capacitance

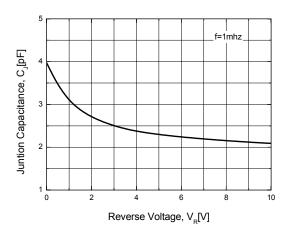
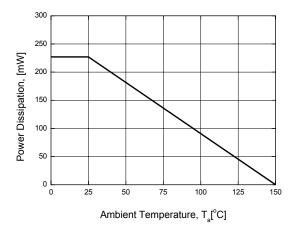
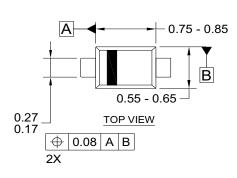
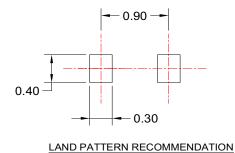
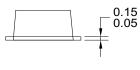


Figure 4. Power Derating

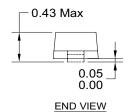








SIDE VIEW



NOTES:

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- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

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- E) DRAWING FILE NAME: SOD923F02REV1





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